



Click [here](#) for the 3D model.

| Dimensions | |
|------------|-----------------|
| Chip Size | 1210 |
| L | 3.3mm +/-0.4mm |
| W | 2.6mm +/-0.3mm |
| T | 2.5mm +/-0.30mm |
| B | 0.6mm +/-0.25mm |

| Packaging Specifications | |
|--------------------------|-----------|
| Packaging | Bulk, Bag |
| Packaging Quantity | 1 |

| General Information | |
|---------------------|---------------------------------------|
| Series | SMD Comm X7R HV Flex |
| Style | SMD Chip |
| Description | SMD, MLCC, FT-CAP, Temperature Stable |
| Features | FT-CAP, Temperature Stable |
| RoHS | Yes |
| Termination | Flexible Termination |
| Marking | No |
| AEC-Q200 | No |
| Component Weight | 135 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| Specifications | |
|--|---|
| Capacitance | 0.033 uF |
| Measurement Condition | 1 kHz 1.0Vrms |
| Capacitance Tolerance | 10% |
| Voltage DC | 1500 VDC |
| Dielectric Withstanding Voltage | 1800 VDC |
| Temperature Range | -55/+125°C |
| Temperature Coefficient | X7R |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 15%, 1kHz 1.0Vrms |
| Dissipation Factor | 2.5% 1kHz 1.0Vrms |
| Aging Rate | 3% Loss/Decade Hour: Referee Time is 1000 Hours |
| Insulation Resistance | 3.0303 GOhms |

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

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